



### P-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

| BV <sub>DSS</sub> | R <sub>DS(ON)</sub> Max        | I <sub>D</sub> Max<br>T <sub>A</sub> = +25°C |
|-------------------|--------------------------------|--|
|                   | 29mΩ @ V <sub>GS</sub> = -4.5V | -6.9A  |
| -20V              | 39mΩ @ V <sub>GS</sub> = -2.5V | -5.9A  |

## **Features and Benefits**

- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm<sup>2</sup>
- Low Gate Threshold Voltage
- Low On-Resistance
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotive-products/.

 This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

https://www.diodes.com/quality/product-definitions/

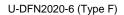
## **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>), yet maintain superior switching performance, making it ideal for high efficiency power management applications.

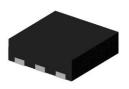
- Battery Management Application
- Power Management Functions
- DC-DC Converters

### **Mechanical Data**

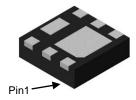
- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe.
  Solderable per MIL-STD-202, Method 208 4
- Weight: 0.0065 grams (Approximate)



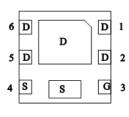




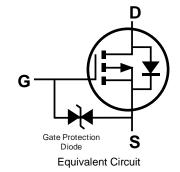
Top View



Bottom View



Pin Out Bottom View



### **Ordering Information** (Note 4)

| Part Number    | Case                 | Packaging          |
|----------------|----------------------|--------------------|
| DMP2035UFDF-7  | U-DFN2020-6 (Type F) | 3,000/Tape & Reel  |
| DMP2035UFDF-13 | U-DFN2020-6 (Type F) | 10.000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/



# **Marking Information**

Site 1



P8 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Kev

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|-----------------|------|-----|------|------|------|------|------|------|------|------|------|------|
| Year            | 2016 |     | 2020 | 2021 | 2022 | 2023 | 2024 | 2025 | 2026 | 2027 | 2028 | 2029 |
| Code            | D    |     | Н    |      | J    | K    | L    | М    | N    | 0    | Р    | R    |
|                 |      |     |      |      |      |      |      |      |      |      |      |      |
| Month           | Jan  | Feb | Mar  | Apr  | May  | Jun  | Jul  | Aug  | Sep  | Oct  | Nov  | Dec  |

Site 2



P8 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 0 = 2020) W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Kev

| Date Code Key |      |   |      |      |      |       |      |      |      |      |          |      |
|---------------|------|---|------|------|------|-------|------|------|------|------|----------|------|
| Year          | 2016 |   | 2020 | 2021 | 2022 | 2023  | 2024 | 2025 | 2026 | 2027 | 2028     | 2029 |
| Code          | 6    |   | 0    | 1    | 2    | 3     | 4    | 5    | 6    | 7    | 8        | 9    |
|               |      |   |      |      |      |       |      |      |      |      |          |      |
| Week          | 1-26 |   |      |      |      | 27-52 |      |      |      | 53   |          |      |
| Code          |      | Α | Z    |      |      | a-    | -Z   |      |      | 7    | <u>'</u> |      |
|               |      |   |      |      |      |       |      |      |      |      |          |      |
| Internal Code | Sun  | 1 | Mon  |      | Tue  | W     | ed   | Thu  |      | Fri  |          | Sat  |
| Code          | Т    |   | U    |      | V    | V     | V    | Х    |      | Υ    |          | Z    |



## **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

| Characteristic  | Symbol          | Value                            | Unit            |              |    |
|---|-----------------|----------------------------------|-----------------|--------------|----|
| Drain-Source Voltage                                      | $V_{DSS}$       | -20                              | V               |              |    |
| Gate-Source Voltage                                       |                 |                                  | Vgss            | ±8           | V  |
| Continuous Drain Current (Note 6) Vos - 4 5V              | Steady<br>State | $T_A = +25$ °C<br>$T_A = +70$ °C | l <sub>D</sub>  | -6.9<br>-5.5 | А  |
| Continuous Drain Current (Note 6) V <sub>GS</sub> = -4.5V | lo              | -8.1<br>-6.5                     | А               |              |    |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%         | )               |                                  | I <sub>DM</sub> | -40          | Α  |
| Continuous Source-Drain Diode Current (Note 6)            | Is              | -2.5                             | Α               |              |    |
| Avalanche Current (Note 7) L = 0.1mH                      | I <sub>AS</sub> | -21                              | Α               |              |    |
| Avalanche Energy (Note 7) L = 0.1mH                       |                 |                                  | Eas             | 23           | mJ |

# Thermal Characteristics ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

| Characteristic                                   | Symbol                 | Value          | Unit        |      |  |
|--|------------------------|----------------|-------------|------|--|
| Total Bower Dissipation (Note 5)                 | $T_A = +25^{\circ}C$   | Pp             | 0.66        | W    |  |
| Total Power Dissipation (Note 5)                 | $T_A = +70$ °C         | PD             | 0.42        | VV   |  |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State           | Reja           | 180         | °C/W |  |
| Thermal Resistance, Junction to Ambient (Note 5) | t<10s                  | Көја           | 135         | C/VV |  |
| Total Power Dissipation (Note 6)                 | T <sub>A</sub> = +25°C | 0              | 2.03        | W    |  |
| Total Power Dissipation (Note 6)                 | T <sub>A</sub> = +70°C | P <sub>D</sub> | 1.31        | VV   |  |
| Thermal Peciatones, Junction to Ambient (Note 6) | Steady State           | Reja           | 63          |      |  |
| Thermal Resistance, Junction to Ambient (Note 6) | КӨЈА                   | 43             | °C/W        |      |  |
| Thermal Resistance, Junction to Case (Note 6)    | $R_{	heta JC}$         | 17.5           |             |      |  |
| Operating and Storage Temperature Range          |                        | TJ, TSTG       | -55 to +150 | °C   |  |

## Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic   | Symbol              | Min  | Тур   | Max  | Unit  | Test Condition                                |
|--|---------------------|------|-------|------|-------|---|
| OFF CHARACTERISTICS (Note 8)                           |                     |      |       |      |       |   |
| Drain-Source Breakdown Voltage                         | BVDSS               | -20  |       | _    | V     | $V_{GS} = 0V, I_{D} = -250\mu A$              |
| Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C | I <sub>DSS</sub>    | _    | _     | -1   | μΑ    | $V_{DS} = -16V, V_{GS} = 0V$                  |
| Gate-Source Leakage                                    | lgss                | _    | _     | ±10  | μΑ    | $V_{GS} = \pm 8V$ , $V_{DS} = 0V$             |
| ON CHARACTERISTICS (Note 8)                            |                     |      |       |      |       |   |
| Gate Threshold Voltage                                 | V <sub>GS(TH)</sub> | -0.4 | I     | -1.0 | V     | $V_{DS} = V_{GS}$ , $I_D = -250\mu A$         |
|  |                     |      | 20    | 29   |       | $V_{GS} = -4.5V$ , $I_{D} = -6.4A$            |
| Static Drain-Source On-Resistance                      | Descent             |      | 24    | 39   | mΩ    | $V_{GS} = -2.5V$ , $I_{D} = -4.8A$            |
| Static Drain-Source Off-Resistance                     | RDS(ON)             | _    | 31    | 60   | 11177 | $V_{GS} = -1.8V, I_{D} = -2.5A$               |
|  |                     |      | 40    | 120  |       | $V_{GS} = -1.5V$ , $I_{D} = -1.5A$            |
| Diode Forward Voltage                                  | VsD                 | _    | -0.7  | -1.2 | V     | V <sub>G</sub> S = 0V, I <sub>S</sub> = -1.0A |
| DYNAMIC CHARACTERISTICS (Note 9)                       |                     |      |       |      |       |   |
| Input Capacitance                                      | Ciss                | _    | 1,808 | _    |       | 45)/ )/ 6)/                                   |
| Output Capacitance                                     | Coss                | _    | 155   | _    | pF    | $V_{DS} = -15V, V_{GS} = 0V,$<br>f = 1.0MHz   |
| Reverse Transfer Capacitance                           | Crss                | _    | 117   | _    |       | I = 1.0WII IZ                                 |
| Gate Resistance  | Rg                  | _    | 32    | _    | Ω     | $V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$    |
| Total Gate Charge (V <sub>GS</sub> = -4.5V)            | $Q_G$               | _    | 20.5  | _    |       | 10)/ )/ 15)/                                  |
| Gate-Source Charge                                     | Qgs                 | _    | 2.8   | _    | nC    | $V_{DS} = -10V$ , $V_{GS} = -4.5V$ ,          |
| Gate-Drain Charge                                      | Q <sub>GD</sub>     | _    | 4.1   | _    |       | $I_D = -4.0A$                                 |
| Turn-On Delay Time                                     | td(on)              | _    | 9.1   | _    |       |   |
| Turn-On Rise Time                                      | t <sub>R</sub>      | _    | 12.3  | _    | 20    | $V_{DS} = -10V$ , $V_{GS} = -4.5V$ ,          |
| Turn-Off Delay Time                                    | t <sub>D(OFF)</sub> | _    | 120   | _    | ns    | $R_G = 6\Omega$ , $I_D = -1.0A$               |
| Turn-Off Fall Time                                     | t <sub>F</sub>      | _    | 54    | _    |       |   |
| Reverse Recovery Time                                  | trr                 | _    | 23.1  | _    | ns    | I <sub>F</sub> = -1.0A, di/dt = 100A/µs       |
| Reverse Recovery Charge                                | Q <sub>RR</sub>     |      | 8.3   |      | nC    | $I_F = -1.0A$ , $di/dt = 100A/\mu s$          |

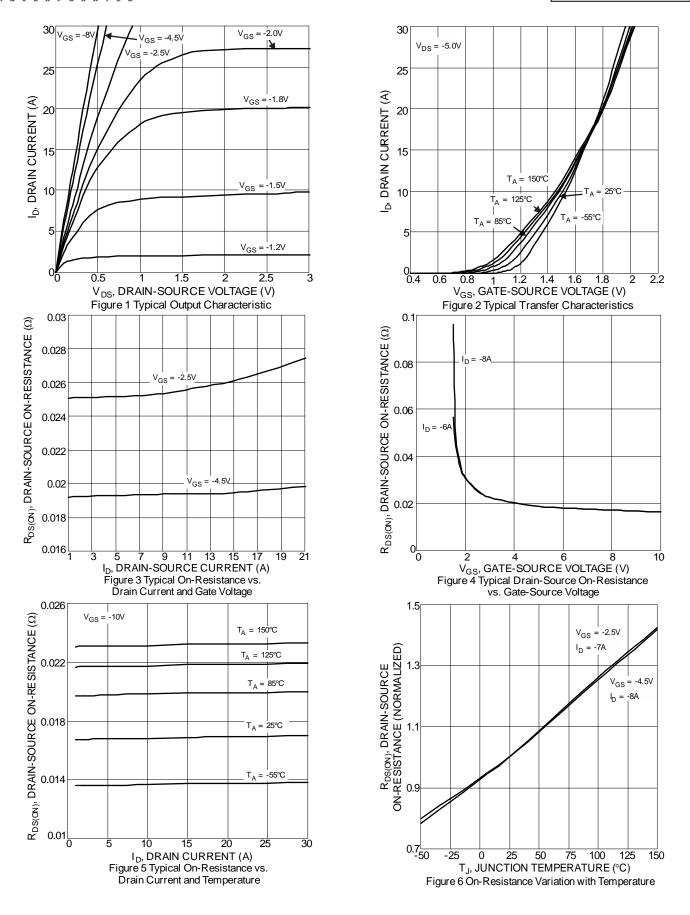
Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

<sup>6.</sup> Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate. 7.  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J$  = +25°C.

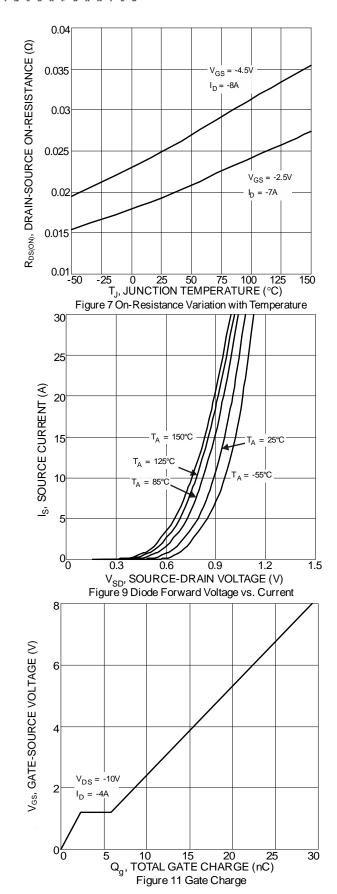
<sup>8.</sup> Short duration pulse test used to minimize self-heating effect.

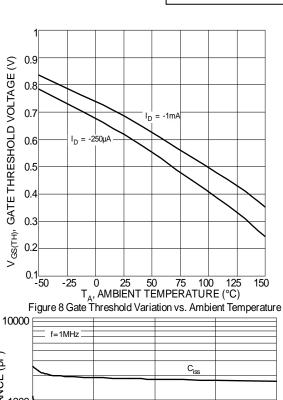
<sup>9.</sup> Guaranteed by design. Not subject to product testing.

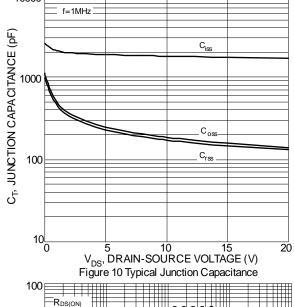


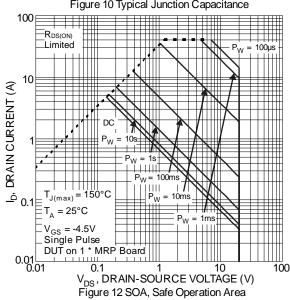




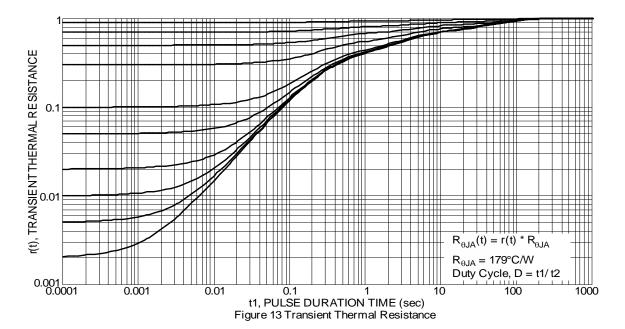










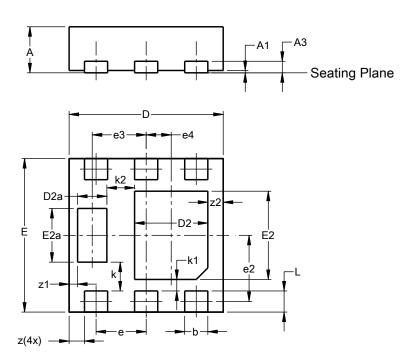




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### U-DFN2020-6 (Type F)

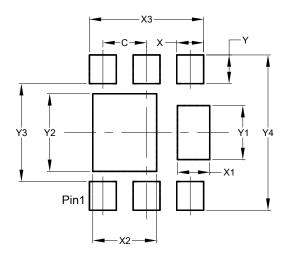


| U-DFN2020-6 |             |               |       |  |  |  |  |  |  |
|-------------|-------------|---------------|-------|--|--|--|--|--|--|
|             | (Type F)    |               |       |  |  |  |  |  |  |
| Dim         | Min Max Typ |               |       |  |  |  |  |  |  |
| Α           | 0.57        | 0.57 0.63 0.0 |       |  |  |  |  |  |  |
| A1          | 0.00        | 0.05          | 0.03  |  |  |  |  |  |  |
| A3          | -           | -             | 0.15  |  |  |  |  |  |  |
| b           | 0.25        | 0.35          | 0.30  |  |  |  |  |  |  |
| D           | 1.95        | 2.05          | 2.00  |  |  |  |  |  |  |
| D2          | 0.85        | 1.05          | 0.95  |  |  |  |  |  |  |
| D2a         | 0.33        | 0.43          | 0.38  |  |  |  |  |  |  |
| Е           | 1.95        | 2.05          | 2.00  |  |  |  |  |  |  |
| E2          | 1.05        | 1.25          | 1.15  |  |  |  |  |  |  |
| E2a         | 0.65        | 0.75          | 0.70  |  |  |  |  |  |  |
| е           |             | 0.65 BS       | C     |  |  |  |  |  |  |
| e2          | (           | ).863 BS      | SC    |  |  |  |  |  |  |
| е3          |             | 0.70 BS       | С     |  |  |  |  |  |  |
| e4          | (           | ).325 BS      | SC    |  |  |  |  |  |  |
| k           |             | 0.37 BS       | C     |  |  |  |  |  |  |
| k1          | 0.15 BSC    |               |       |  |  |  |  |  |  |
| k2          |             | 0.36 BS       | C     |  |  |  |  |  |  |
| L           | 0.225       | 0.325         | 0.275 |  |  |  |  |  |  |
| Z           | 0.20 BSC    |               |       |  |  |  |  |  |  |
| <b>z</b> 1  | (           | 0.110 BSC     |       |  |  |  |  |  |  |
| z2          |             | 0.20 BS       | С     |  |  |  |  |  |  |
| All C       | Dimens      | ions in       | mm    |  |  |  |  |  |  |

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### U-DFN2020-6 (Type F)



| Dimensions    | Value   |
|---------------|---------|
| Dillielisions | (in mm) |
| С             | 0.650   |
| Х             | 0.400   |
| X1            | 0.480   |
| X2            | 0.950   |
| Х3            | 1.700   |
| Υ             | 0.425   |
| Y1            | 0.800   |
| Y2            | 1.150   |
| Y3            | 1.450   |
| Y4            | 2.300   |



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